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Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

- 1. (original) A self-adhesive addition-crosslinking silicone composition, comprising
- (A) diorganopolysiloxane(s) of the general formula (1)

$$R_a^1 R_b^2 SiO_{(4-a-b)/2}$$
 (1),

in which

- R^1 is a hydroxyl radical or a monovalent, optionally halogen-substituted C_{1-20} hydrocarbon radical optionally containing O, N, S or P atoms and free of aliphatically unsaturated groups,
- R^2 is a monovalent, aliphatically unsaturated, optionally halogen-substituted C_{2-10} hydrocarbon radical optionally containing O, N, S or P atoms,
- b has a value from 0.003 to 2, with the proviso that 1.5 < (a+b) < 3.0, that on average at least two aliphatically unsaturated radicals R² are present per molecule, and that the viscosity of the diorganopolysiloxane(s) (A), determined at 25°C, is 1 mPa·s to 40,000 Pa·s;
- (B) organohydrogenpolysiloxane(s) of the general formula (2)

$$R_c^3 R_d^4 R_e^5 H_f SiO_{(4-c-d-2e-f)/2}$$
 (2),

in which

- R^3 is a monovalent aliphatically saturated C_{1-20} hydrocarbon radical,
- R^4 is (a) an optionally halogen-substituted monovalent C_{6-15} hydrocarbon radical which contains at least one aromatic C_6 -ring, or
 - (b) a halogen-substituted, saturated monovalent C_{2-20} hydrocarbon radical optionally containing O, N, S or P atoms,

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- R^5 is a bivalent, optionally halogen-substituted C_{6-20} hydrocarbon radical Si-bonded at both ends, optionally containing O, N, S or P atoms,
- c, d, e and f denote positive numbers, with the proviso that the organohydrogenpolysiloxane (B) contains on average 3 to less than 20 SiH groups per molecule, that the relationship: $0.05 < 100 \ (d+e)/(c+d+e+f) < 12$ is fulfilled, and that the viscosity of the organohydrogenpolysiloxane (B), determined at 25°C, is 1 mPa·s to 100 Pa·s;
- (C) organosilicon compound(s) having epoxy groups and hydrolyzable groups of the general formula (3)

$$R_{g}^{7}R_{h}^{8}R_{i}^{9}SiO_{(4-g-h-i)/2}$$
(3)

and/or their partial hydrolysis products, in which

- R^7 is a hydrogen radical, a hydroxyl radical or an optionally halogen- or cyano-substituted, saturated monovalent C_{1-20} hydrocarbon radical optionally containing O, N, S or P atoms,
- R^8 is an optionally halogen-substituted monovalent C_{2-20} hydrocarbon radical containing at least one epoxy group, optionally containing O, N, S or P atoms,
- R^9 is a hydrolyzable, monovalent optionally halogen-substituted C_{1-20} hydrocarbon radical bonded to Si via an Si-O-C-, Si-O-N- or Si-N- link, optionally containing O, N, S or P,

with the proviso that $4>g\ge0$, 4>h>0, 4>i>0, $4\ge(h+i)>0$ and $4\ge(g+h+i)$; and (D) a hydrosilylation catalyst.

- 2. (original) The self-adhesive addition-crosslinking silicone composition of claim 1, wherein the viscosity of the component (B) measured at 25°C, is 2 mPa·s to 1 Pa·s.
- 3. (original) A process for the preparation of self-adhesive addition-crosslinked silicone elastomers, in which the self-adhesive addition-crosslinking silicone compositions of claim 1 is heated to 30°C to 250°C.

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4. (original) A process for the preparation of self-adhesive addition-crosslinked silicone elastomers, in which the self-adhesive addition-crosslinking silicone compositions of claim 2 is heated to 30°C to 250°C.

5. (original) A self-adhesive addition-crosslinked silicone elastomer obtained by the process of claim 3.

6. (cancelled)

- 7. (original) A process for bonding an addition-crosslinkable silicone composition to a substrate, in which the self-adhesive addition-crosslinkable silicone compositions of claim 1 is applied to the substrate and crosslinked by heating to 30°C to 250°C.
- 8. (original) A process for bonding an addition-crosslinkable silicone composition to a substrate, in which the self-adhesive addition-crosslinkable silicone compositions of claim 2 is applied to the substrate and crosslinked by heating to 30°C to 250°C.
 - 9. (original) A composite material obtained by the process of claim 7.
 - 10. (original) A composite material obtained by the process of claim 8.

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